## OSICS DFB LANWDM

## DISTRIBUTED FFFDBACK LASER

The OSICS LANWDM modules, based on high-performance distributed feedback laser diodes, are perfect for LR4 and ER4 testing of silicon photonics chips.



External and internal LF modulation

10 dBm output power from a single mode fiber with a stability of  $\pm 0.01$  dB over 1 hour

±30 pm wavelength accuracy and stability of ±5 pm over one hour

Wavelength grid matched to LANWDM channels with typical tuning range of 1.8  $\mbox{nm}$ 

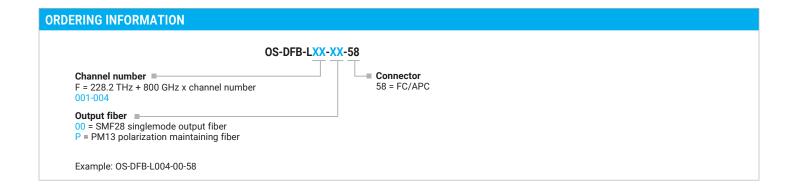


SPECIFICATIONS				
			SMF	PM13
Models <sup>a</sup>	Channel 1		1309.14 nm / 229.0 THz	
	Channel 2		1304.58 nm / 229.8 THz	
	Channel 3		1300.05 nm / 230.6 THz	
	Channel 4		1295.56 nm / 231.4 THz	
Wavelength	Channel center <sup>a</sup>		Grid matched	
	Tuning range (nm) <sup>a</sup>		1.6 (1.8 typical)	
	Accuracy (nm) <sup>b</sup>		±0.03	
	Stability over 1 hour (nm) b, c, d		±0.005	
	Stability over 24 hours (nm) b, c, d		±0.005 typical	
Power	Maximum (mW)		10	
	Stability over 1 hour (dB) b, c, d		±0.01	
	Stability over 24 hours (dB) b, c, d		±0.01 typical	
	Optical isolation (dB)		> 30	
	Relative intensity noise (RIN) (dB/Hz) <sup>e</sup>		< -130	
Spectrum	Laser line width (MHz)		< 10	
	SMSR (dB) <sup>b</sup>		> 30 (40 typical)	
Modulations	TTL	Internal External	1 Hz to 8 16 Hz to	
	Analog (external/front panel)		150 Hz to 150 MHz	
	Stimulated brillouin scattering (SBS) suppression (internal)	Waveform Frequency range (kHz) Modulation depth (%)	Sir 10 to 0 to	100
Interfaces on module front panel <sup>f</sup>	Enable key with status LED		Power up laser	
	Optical fiber		SMF	PM13
	Fiber alignment to connector key	y	n/a	Slow axis
	Polarization extinction ratio (PER) (dB)		n/a	> 17
	Optical connector		FC/APC narrow key	
	Electrical connector		Coaxial SMB - 50 Ω	
Others	Laser safety		Class 1 M	
	Dimensions (W x H x D)		35 mm x 128 mm x 230 mm (1 <sup>3</sup> / <sub>8</sub> in x 5 in x 9 in)	
	Weight		1.1 kg (2.43 lb)	



- a. Location of channel center: lower boundary of the range + 0.4 nm < channel center < upper boundary of the range -0.4 nm.
- b. After warm-up and at maximum power.
- c. At a constant temperature.
- d. Measured with an APC terminated jumper on a power meter.
- e. RIN within the range 100 MHz 20 GHz measured at 10 dBm output power with RBW = 30 kHz.
- f. See OSICS mainframe specifications sheet for details on OSICS common specifications and interfaces on the rear panel.





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